

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

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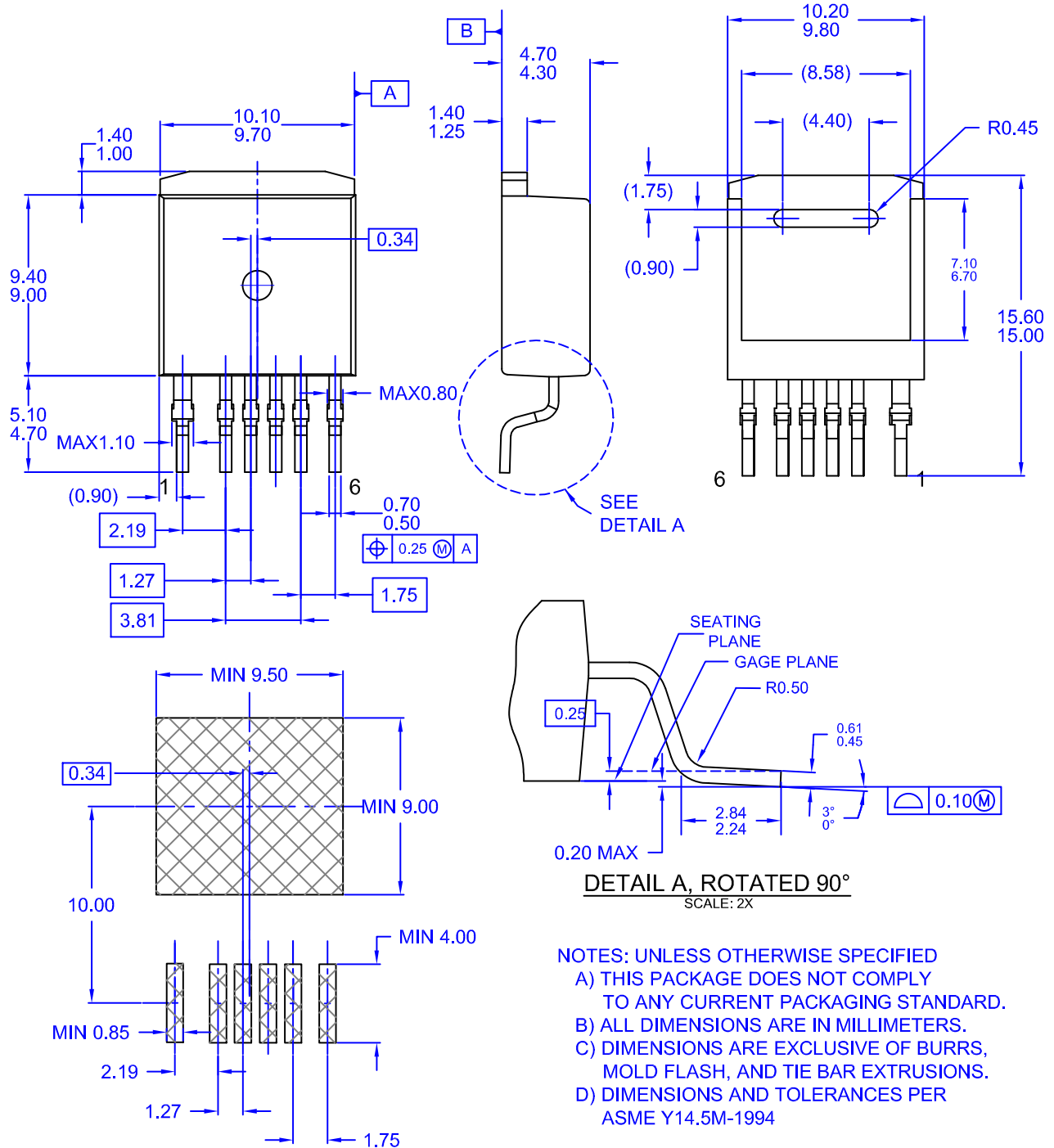


D2PAK6 (TO-263 6 LD)

CASE 418AX

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LAND PATTERN RECOMMENDATION

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